

**TCB**

**GRANT OF EQUIPMENT  
AUTHORIZATION**

**TCB**

**Certification**

**Issued Under the Authority of the  
Federal Communications Commission**

**By:**

**Nemko North America, INC.  
303 River Road  
Ottawa, Ontario, K1V 1H2  
Canada**

**Date of Grant: 09/17/2018**

**Application Dated: 09/15/2018**

**ON Semiconductor  
611 Kumpf Dr. Unit 200  
P.O. Box N2V 1K8,  
Waterloo, N2V 1K8  
Canada**

**Attention: David Banbury , Design Engineer**

**NOT TRANSFERABLE**

EQUIPMENT AUTHORIZATION is hereby issued to the named GRANTEE, and is VALID ONLY for the equipment identified hereon for use under the Commission's Rules and Regulations listed below.

**FCC IDENTIFIER:** 2APD9-RSL10SIP  
**Name of Grantee:** ON Semiconductor  
**Equipment Class:** Digital Transmission System  
**Notes:** Bluetooth 5 System-in-Package Module  
**Modular Type:** Single Modular

<u>Grant Notes</u>	<u>FCC Rule Parts</u>	<u>Frequency Range (MHZ)</u>	<u>Output Watts</u>	<u>Frequency Tolerance</u>	<u>Emission Designator</u>
	<b>15C</b>	<b>2402.0 - 2480.0</b>	<b>0.00348</b>		

Power listed is conducted. The separation distance between this device and the user must be greater than or equal to 5 mm.

